74HC163; 74HCT163

Presettable synchronous 4-bit binary counter; synchronous reset

Rev. 5 — 12 October 2018 Product data sheet

1. General description

The 74HC163; 74HCT163 is a synchronous presettable binary counter with an internal look-head carry. Synchronous operation is provided by having all flip-flops clocked simultaneously on the positive-going edge of the clock (CP). The outputs (Q0 to Q3) of the counters may be preset to a HIGH or LOW. A LOW at the parallel enable input ($\overline{PE}$) disables the counting action. It causes the data at the data inputs (D0 to D3) to be loaded into the counter on the positive-going edge of the clock. Preset takes place regardless of the levels at count enable inputs (CEP and CET). A LOW at the master reset input ($\overline{MR}$) sets Q0 to Q3 LOW after the next positive-going transition on the clock input (CP). This action occurs regardless of the levels at input pins $\overline{PE}$, CET and CEP. This synchronous reset feature enables the designer to modify the maximum count with only one external NAND gate. The look-ahead carry simplifies serial cascading of the counters. Both CEP and CET must be HIGH to count. The CET input is fed forward to enable the terminal count output (TC). The TC output thus enabled will produce a HIGH output pulse of a duration approximately equal to a HIGH output of Q0. This pulse can be used to enable the next cascaded stage. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC}.

The CP to TC propagation delay and CEP to CP set-up time determine the maximum clock frequency for the cascaded counters according to the following formula:

$$f_{max} = \frac{1}{t_{P(max)}(\text{CPtoTC}) + t_{SU}(\text{CEPtoCP})}$$

2. Features and benefits

- Complies with JEDEC standard no. 7A
- Input levels:
  - For 74HC163: CMOS level
  - For 74HCT163: TTL level
- Synchronous counting and loading
- 2 count enable inputs for n-bit cascading
- Synchronous reset
- Positive-edge triggered clock
- ESD protection:
  - HBM JESD22-A114F exceeds 2 000 V
  - MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

3. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74HC163D	-40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1
74HCT163D				

Type number	Package			
	Temperature range	Name	Description	Version
74HC163DB	-40 °C to +125 °C	SSOP16	plastic shrink small outline package; 16 leads; body width 5.3 mm	SOT338-1
74HCT163DB				
74HC163PW	-40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1
74HCT163PW				

4. Functional diagram

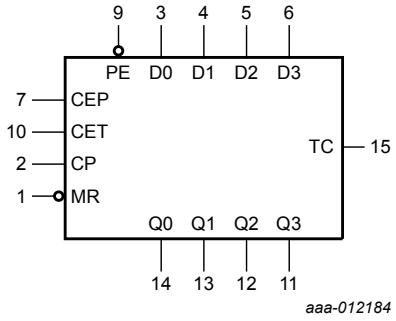


Fig. 1. Logic symbol

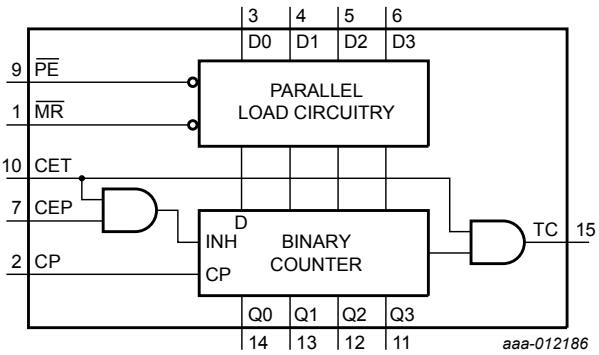


Fig. 2. Functional diagram

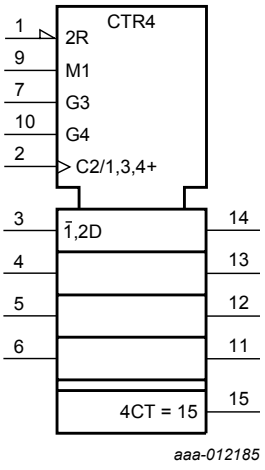


Fig. 3. IEC logic symbol

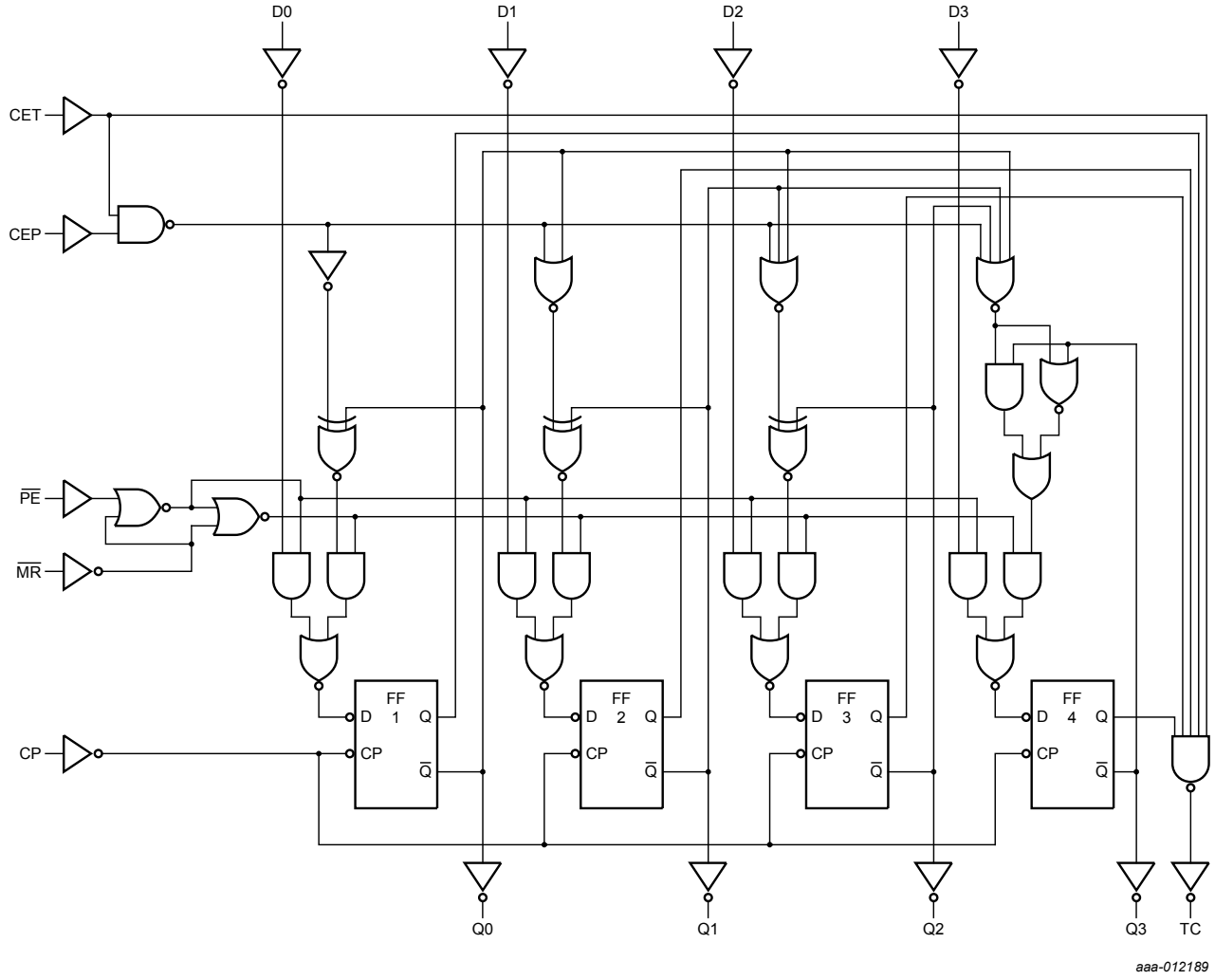


Fig. 4. Logic diagram

5. Pinning information

5.1. Pinning

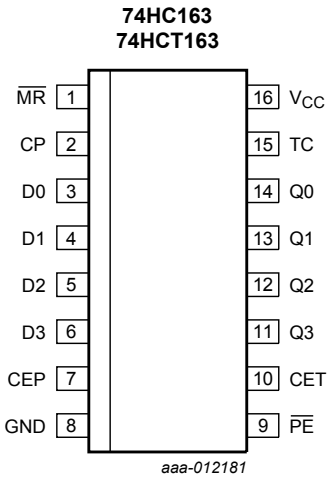


Fig. 5. Pin configuration SOT109-1 (SO16)

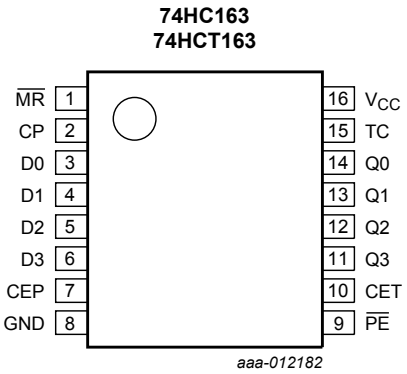


Fig. 6. Pin configuration SOT338-1 (SSOP16) and SOT403-1 (TSSOP16)

5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
$\overline{MR}$	1	synchronous master reset (active LOW)
CP	2	clock input (LOW-to-HIGH, edge triggered)
D0, D1, D2, D3	3, 4, 5, 6	data input
CEP	7	count enable input
GND	8	ground (0 V)
$\overline{PE}$	9	parallel enable input (active LOW)
CET	10	count enable carry input
Q0, Q1, Q2, Q3	14, 13, 12, 11	flip-flop output
TC	15	terminal count output
V_{CC}	16	supply voltage

6. Functional description

Table 3. Function table[1]

Operating mode	Inputs						Outputs	
	$\overline{MR}$	CP	CEP	CET	$\overline{PE}$	Dn	Qn	TC
Reset (clear)	l	↑	X	X	X	X	L	L
Parallel load	h	↑	X	X	l	l	L	L
	h	↑	X	X	l	h	H	L
Count	h	↑	h	h	h	X	count	
Hold (do nothing)	h	X	l	X	h	X	qn	L
	h	X	X	l	h	X	qn	L

[1] The TC output is HIGH when CET is HIGH and the counter is at terminal count (HHHH);
H = HIGH voltage level;
h = HIGH voltage level one set-up time prior to the LOW-to-HIGH CP transition;
L = LOW voltage level;
l = LOW voltage level one set-up time prior to the LOW-to-HIGH CP transition;
q = lower case letters indicate the state of the referenced output one set-up time prior to the LOW-to-HIGH CP transition;
X = don't care;
↑ = LOW-to-HIGH clock transition.

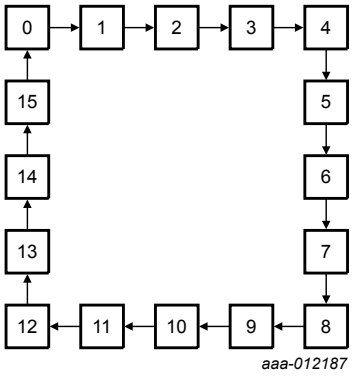
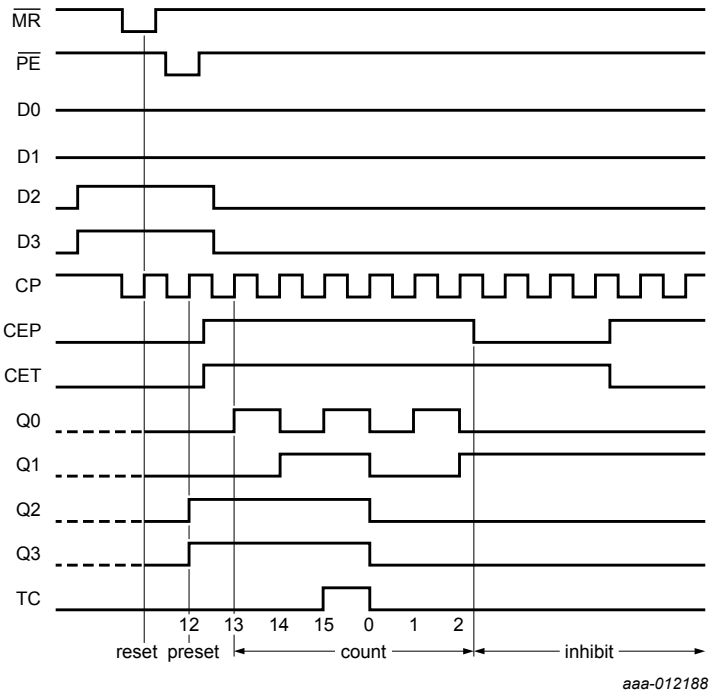


Fig. 7. State diagram



Sequence

reset outputs to zero; preset to binary 12; count to 13, 14, 15, zero, one and two; inhibit.

Fig. 8. Typical timing sequence

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+7.0	V
I_{IK}	input clamping current	$V_I < -0.5$ V or $V_I > V_{CC} + 0.5$ V	-	±20	mA
I_{OK}	output clamping current	$V_O < -0.5$ V or $V_O > V_{CC} + 0.5$ V	-	±20	mA
I_O	output current	$V_O = -0.5$ V to $V_{CC} + 0.5$ V	-	±25	mA
I_{CC}	supply current		-	50	mA
I_{GND}	ground current		-50	-	mA
T_{stg}	storage temperature		-65	+150	°C
P_{tot}	total power dissipation	SO16 package [1]	-	500	mW
		(T)SSOP16 package [1]	-	500	mW

[1] For SO16 packages: above 70 °C the value of P_{tot} derates linearly at 8 mW/K.
For (T)SSOP16 packages: above 60 °C the value of P_{tot} derates linearly at 5.5 mW/K.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	74HC163			74HCT163			Unit
			Min	Typ	Max	Min	Typ	Max	
V_{CC}	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
V_I	input voltage		0	-	V_{CC}	0	-	V_{CC}	V
V_O	output voltage		0	-	V_{CC}	0	-	V_{CC}	V
T_{amb}	ambient temperature		-40	+25	+125	-40	+25	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	V_{CC} = 2.0 V	-	-	625	-	-	-	ns/V
		V_{CC} = 4.5 V	-	1.67	139	-	1.67	139	ns/V
		V_{CC} = 6.0 V	-	-	83	-	-	-	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
74HC163										
V_{IH}	HIGH-level input voltage	V_{CC} = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
		V_{CC} = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V_{CC} = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
V_{IL}	LOW-level input voltage	V_{CC} = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
		V_{CC} = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V_{CC} = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V
V_{OH}	HIGH-level output voltage	V_I = V_{IH} or V_{IL}								
		I_O = -20 µA; V_{CC} = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
		I_O = -20 µA; V_{CC} = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		I_O = -20 µA; V_{CC} = 6.0 V	5.9	6.0	-	5.9	-	5.9	-	V
		I_O = -4.0; V_{CC} = 4.5 V	3.98	4.32	-	3.84	-	3.7	-	V
		I_O = -5.2; V_{CC} = 6.0 V	5.48	5.81	-	5.34	-	5.2	-	V
V_{OL}	LOW-level output voltage	V_I = V_{IH} or V_{IL}								
		I_O = 20 µA; V_{CC} = 2.0 V	-	0	0.1	-	0.1	-	0.1	V
		I_O = 20 µA; V_{CC} = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		I_O = 20 µA; V_{CC} = 6.0 V	-	0	0.1	-	0.1	-	0.1	V
		I_O = 4.0 mA; V_{CC} = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
		I_O = 5.2 mA; V_{CC} = 6.0 V	-	0.16	0.26	-	0.33	-	0.4	V
I_I	input leakage current	V_I = V_{CC} or GND; V_{CC} = 6.0 V	-	-	±0.1	-	±1.0	-	±1.0	µA
I_{CC}	supply current	V_I = V_{CC} or GND; I_O = 0 A; V_{CC} = 6.0 V	-	-	8.0	-	80.0	-	160.0	µA
C_I	input capacitance		-	3.5	-	-	-	-	-	pF

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
74HCT163										
V_{IH}	HIGH-level input voltage	V_{CC} = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	2.0	-	V
V_{IL}	LOW-level input voltage	V_{CC} = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	-	0.8	V
V_{OH}	HIGH-level output voltage	V_I = V_{IH} or V_{IL}; V_{CC} = 4.5 V								
		I_O = -20 µA	4.4	4.5	-	4.4	-	4.4	-	V
		I_O = -4.0 mA	3.98	4.32	-	3.84	-	3.7	-	V
V_{OL}	LOW-level output voltage	V_I = V_{IH} or V_{IL}; V_{CC} = 4.5 V								
		I_O = 20 µA	-	0	0.1	-	0.1	-	0.1	V
		I_O = 4.0 mA	-	0.15	0.26	-	0.33	-	0.4	V
I_I	input leakage current	V_I = V_{CC} or GND; V_{CC} = 5.5 V	-	-	±0.1	-	±1.0	-	±1.0	µA
I_{CC}	supply current	V_I = V_{CC} or GND; I_O = 0 A; V_{CC} = 5.5 V	-	-	8.0	-	80.0	-	160.0	µA
ΔI_{CC}	additional supply current	per input pin; V_I = V_{CC} - 2.1 V; other inputs at V_{CC} or GND; V_{CC} = 4.5 V to 5.5 V; I_O = 0 A								
		pin $\overline{MR}$	-	95	342	-	427.5	-	465.5	µA
		pin CP	-	110	396	-	495	-	539	µA
		pin CEP and Dn	-	25	90	-	112.5	-	122.5	µA
		pin CET	-	75	270	-	337.5	-	367.5	µA
		pin $\overline{PE}$	-	30	108	-	135	-	147	µA
C_I	input capacitance		-	3.5	-	-	-	-	-	pF

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); C_L = 50 pF unless otherwise specified; for test circuit see Fig. 14.

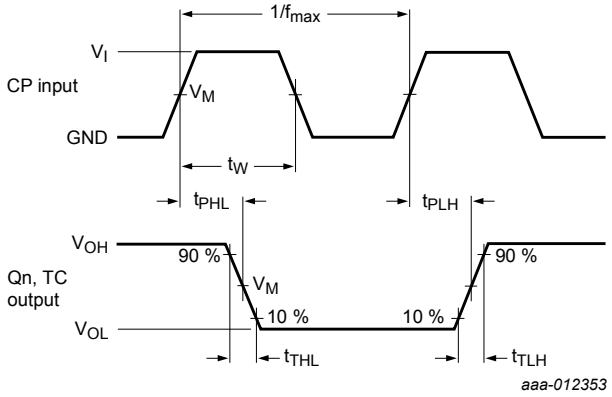
Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
74HC163										
t_{pd}	propagation delay	CP to Qn; see Fig. 9 [1]								
		V_{CC} = 2.0 V	-	55	185	-	230	-	280	ns
		V_{CC} = 4.5 V	-	20	37	-	46	-	56	ns
		V_{CC} = 5.0 V; C_L = 15 pF	-	17	-	-	-	-	-	ns
		V_{CC} = 6.0 V	-	16	31	-	39	-	48	ns
		CP to TC; see Fig. 9								
		V_{CC} = 2.0 V	-	69	215	-	270	-	320	ns
		V_{CC} = 4.5 V	-	25	43	-	54	-	65	ns
		V_{CC} = 5.0 V; C_L = 15 pF	-	21	-	-	-	-	-	ns
		V_{CC} = 6.0 V	-	20	37	-	46	-	55	ns
		CET to TC; see Fig. 10								
		V_{CC} = 2.0 V	-	36	120	-	150	-	180	ns
		V_{CC} = 4.5 V	-	13	24	-	30	-	36	ns
		V_{CC} = 5.0 V; C_L = 15 pF	-	11	-	-	-	-	-	ns
		V_{CC} = 6.0 V	-	10	20	-	26	-	31	ns
t_t	transition time	see Fig. 9 and Fig. 10 [2]								
		V_{CC} = 2.0 V	-	19	75	-	95	-	110	ns
		V_{CC} = 4.5 V	-	7	15	-	19	-	22	ns
		V_{CC} = 6.0 V	-	6	13	-	16	-	19	ns
t_W	pulse width	CP; HIGH or LOW; see Fig. 9								
		V_{CC} = 2.0 V	80	17	-	100	-	120	-	ns
		V_{CC} = 4.5 V	16	6	-	20	-	24	-	ns
		V_{CC} = 6.0 V	14	5	-	17	-	20	-	ns
t_{su}	set-up time	$\overline{MR}$, Dn to CP; see Fig. 11 and Fig. 12								
		V_{CC} = 2.0 V	80	17	-	100	-	120	-	ns
		V_{CC} = 4.5 V	16	6	-	20	-	24	-	ns
		V_{CC} = 6.0 V	14	5	-	17	-	20	-	ns
		$\overline{PE}$ to CP; see Fig. 11								
		V_{CC} = 2.0 V	80	22	-	100	-	120	-	ns
		V_{CC} = 4.5 V	16	8	-	20	-	24	-	ns
		V_{CC} = 6.0 V	14	6	-	17	-	20	-	ns
		CEP, CET to CP; see Fig. 13								
		V_{CC} = 2.0 V	175	58	-	220	-	265	-	ns
		V_{CC} = 4.5 V	35	21	-	44	-	53	-	ns
		V_{CC} = 6.0 V	30	17	-	37	-	45	-	ns

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
t_h	hold time	Dn, $\overline{PE}$, CEP, CET, $\overline{MR}$ to CP; see Fig. 11, Fig. 12 and Fig. 13								
		V_{CC} = 2.0 V	0	-14	-	0	-	0	-	ns
		V_{CC} = 4.5 V	0	-5	-	0	-	0	-	ns
		V_{CC} = 6.0 V	0	-4	-	0		0	-	ns
f_{max}	maximum frequency	CP; see Fig. 9								
		V_{CC} = 2.0 V	5	15	-	4	-	4	-	MHz
		V_{CC} = 4.5 V	27	46	-	22	-	18	-	MHz
		V_{CC} = 5.0 V; C_L = 15 pF	-	51	-	-	-	-	-	MHz
		V_{CC} = 6.0 V	32	55	-	26	-	21	-	MHz
C_{PD}	power dissipation capacitance	V_I = GND to V_{CC}; V_{CC} = 5 V; f_i = 1 MHz [3]	-	33	-	-	-	-	-	pF
74HCT163										
t_{pd}	propagation delay	CP to Qn; see Fig. 9 [1]								
		V_{CC} = 4.5 V	-	23	39	-	49	-	59	ns
		V_{CC} = 5.0 V; C_L = 15 pF	-	20	-	-	-	-	-	ns
		CP to TC; see Fig. 9								
		V_{CC} = 4.5 V	-	29	49	-	61	-	74	ns
		V_{CC} = 5.0 V; C_L = 15 pF	-	25	-	-	-	-	-	ns
		CET to TC; see Fig. 10								
		V_{CC} = 4.5 V	-	17	32	-	44	-	48	ns
		V_{CC} = 5.0 V; C_L = 15 pF	-	14	-	-	-	-	-	ns
t_t	transition time	see Fig. 9 and Fig. 10 [2]								
		V_{CC} = 4.5 V	-	7	15	-	19	-	22	ns
t_W	pulse width	CP; HIGH or LOW; see Fig. 9								
		V_{CC} = 4.5 V	20	6	-	25	-	30	-	ns
t_{su}	set-up time	$\overline{MR}$, Dn to CP; see Fig. 11 and Fig. 12								
		V_{CC} = 4.5 V	20	9	-	25	-	30	-	ns
		$\overline{PE}$ to CP; see Fig. 11								
		V_{CC} = 4.5 V	20	11	-	25	-	30	-	ns
		CEP, CET to CP; see Fig. 13								
		V_{CC} = 4.5 V	40	24	-	50	-	60	-	ns
t_h	hold time	Dn, $\overline{PE}$, CEP, CET, $\overline{MR}$ to CP; see Fig. 11, Fig. 12 and Fig. 13								
		V_{CC} = 4.5 V	0	-5	-	0	-	0	-	ns
f_{max}	maximum frequency	CP; see Fig. 9								
		V_{CC} = 4.5 V	26	45	-	21	-	17	-	MHz
		V_{CC} = 5.0 V; C_L = 15 pF	-	50	-	-	-	-	-	MHz

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
C_{PD}	power dissipation capacitance	V_I = GND to V_{CC} - 1.5 V; V_{CC} = 5 V; f_i = 1 MHz [3]	-	35	-	-	-	-	-	pF

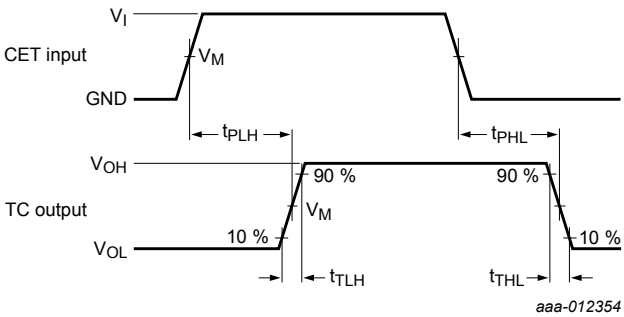
[1] t_{pd} is the same as t_{PHL} and t_{PLH}.
[2] t_t is the same as t_{THL} and t_{TLH}.
[3] C_{PD} is used to determine the dynamic power dissipation (P_D in µW):
$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum(C_L \times V_{CC}^2 \times f_o)$ where:
f_i = input frequency in MHz;
f_o = output frequency in MHz;
C_L = output load capacitance in pF;
V_{CC} = supply voltage in V;
N = number of inputs switching;
$\sum(C_L \times V_{CC}^2 \times f_o)$ = sum of outputs.

10.1. Waveforms and test circuit



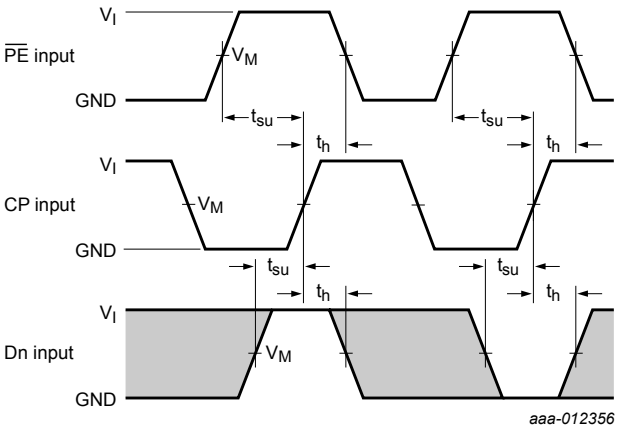
Measurement points are given in Table 8.
Logic levels V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig. 9. The clock (CP) to outputs (Qn, TC) propagation delays, pulse width, output transition times and maximum frequency



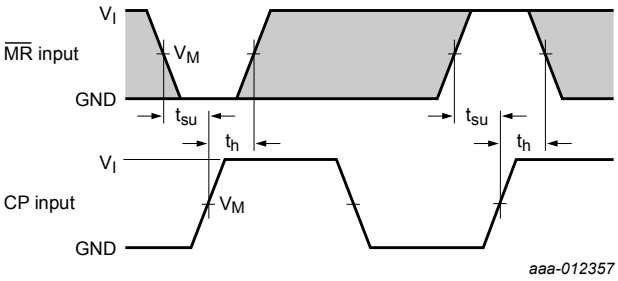
Measurement points are given in Table 8.
Logic levels V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig. 10. The count enable carry input (CET) to terminal count output (TC) propagation delays and output transition times



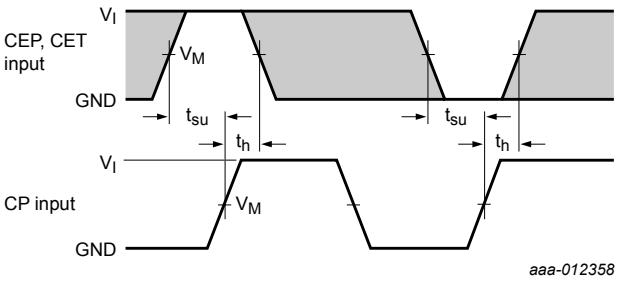
The shaded areas indicate when the input is permitted to change for predictable output performance. Measurement points are given in Table 8.

Fig. 11. The data input (Dn) and parallel enable input ($\overline{PE}$) set-up and hold times



The shaded areas indicate when the input is permitted to change for predictable output performance. Measurement points are given in Table 8.

Fig. 12. The master reset ($\overline{MR}$) set-up and hold times

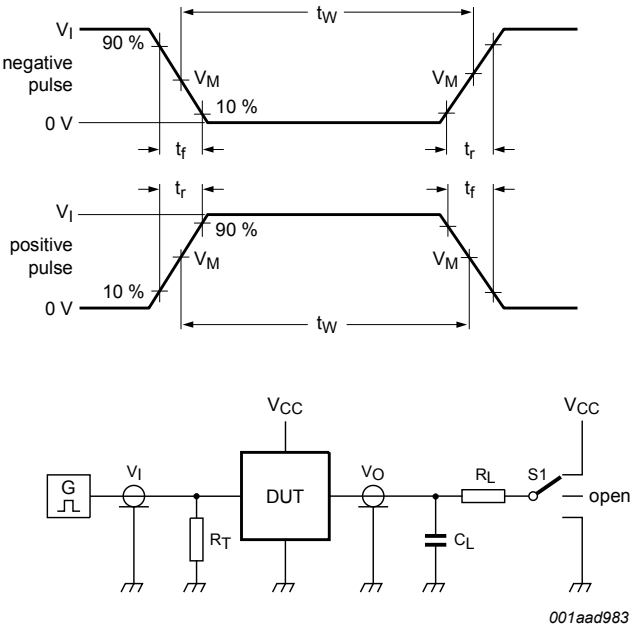


The shaded areas indicate when the input is permitted to change for predictable output performance. Measurement points are given in Table 8.

Fig. 13. The count enable input (CEP) and count enable carry input (CET) set-up and hold times

Table 8. Measurement points

Type	Input		Output
	V_M	V_I	V_M
74HC163	0.5 x V_{CC}	GND to V_{CC}	0.5 x V_{CC}
74HCT163	1.3 V	GND to 3 V	1.3 V



Test data is given in Table 9.

Test circuit definitions:

R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator

C_L = Load capacitance including jig and probe capacitance

R_L = Load resistance.

S1 = Test selection switch

Fig. 14. Test circuit for measuring switching times

Table 9. Test data

Type	Input		Load		S1 position
	V_I	t_r, t_f	C_L	R_L	t_{PHL}, t_{PLH}
74HC163	V_{CC}	6 ns	15 pF, 50 pF	1 kΩ	open
74HCT163	3 V	6 ns	15 pF, 50 pF	1 kΩ	open

11. Application information

The 74HC163; 74HCT63 facilitate designing counters of any modulus with minimal external logic. The output is glitch-free due to the synchronous reset.

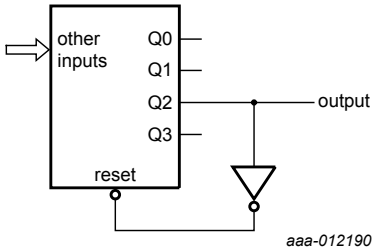


Fig. 15. Modulo-5 counter

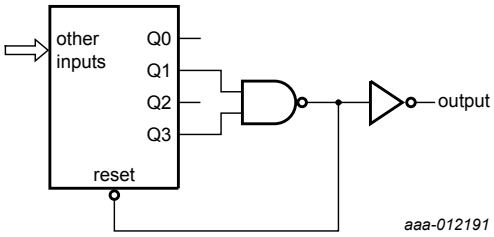
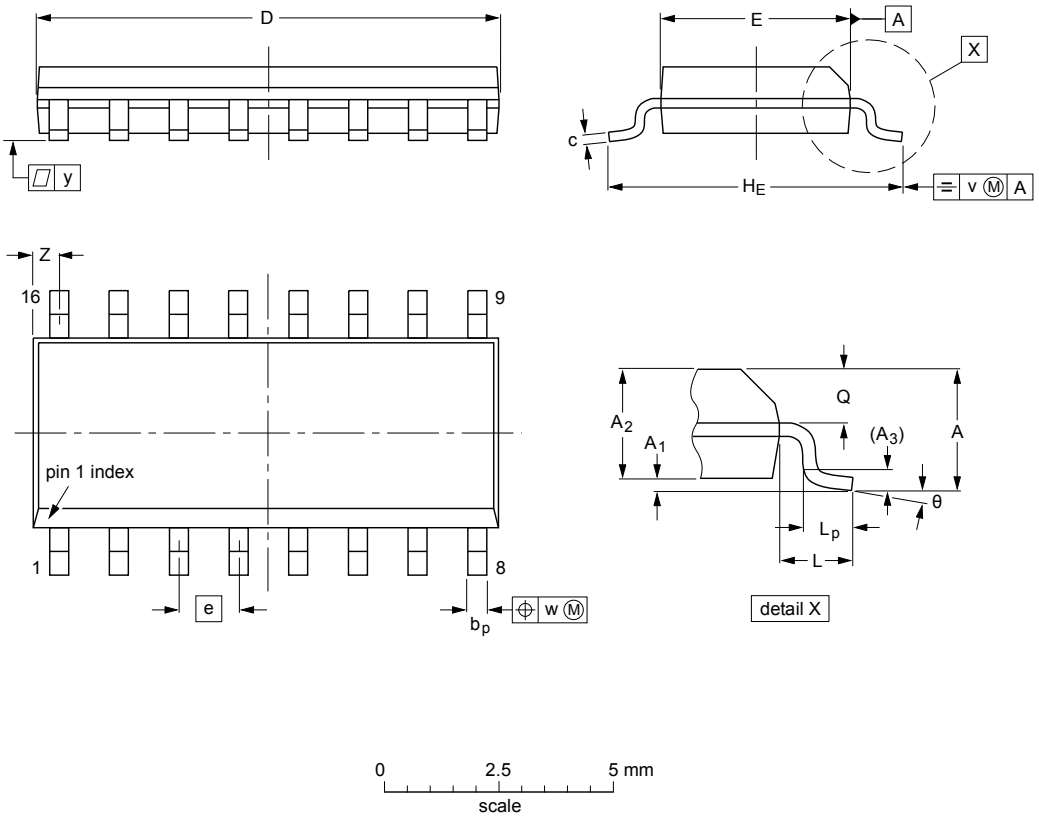


Fig. 16. Modulo-11 counter

12. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm **SOT109-1**



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A_1	A_2	A_3	b_p	c	$D^{(1)}$	$E^{(1)}$	e	H_E	L	L_p	Q	v	w	y	$Z^{(1)}$	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8^o 0^o
inches	0.069	0.010 0.004	0.057 0.049	0.01	0.019 0.014	0.0100 0.0075	0.39 0.38	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016	0.028 0.020	0.01	0.01	0.004	0.028 0.012	

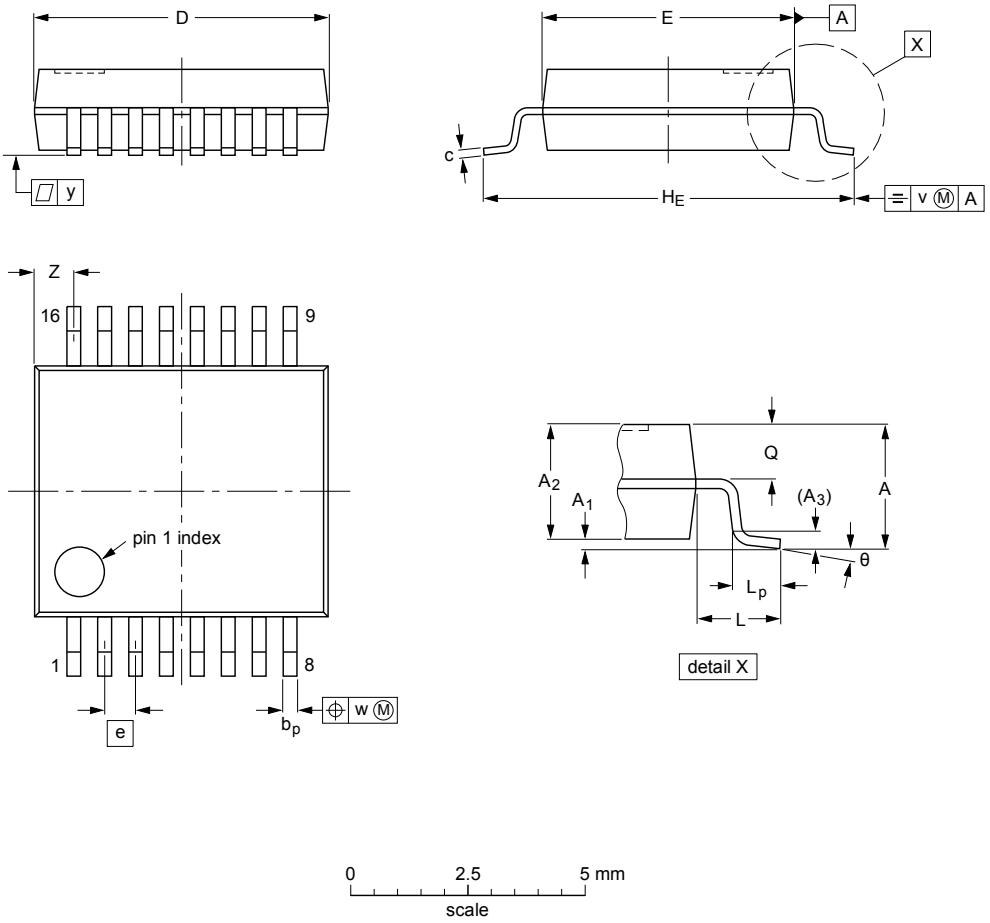
Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT109-1	076E07	MS-012				~~99-12-27~~ 03-02-19

Fig. 17. Package outline SOT109-1 (SO16)

SSOP16: plastic shrink small outline package; 16 leads; body width 5.3 mm **SOT338-1**



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A_1	A_2	A_3	b_p	c	D (1)	E (1)	e	H_E	L	L_p	Q	v	w	y	Z (1)	θ
mm	2	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	6.4 6.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	1.00 0.55	8^o 0^o

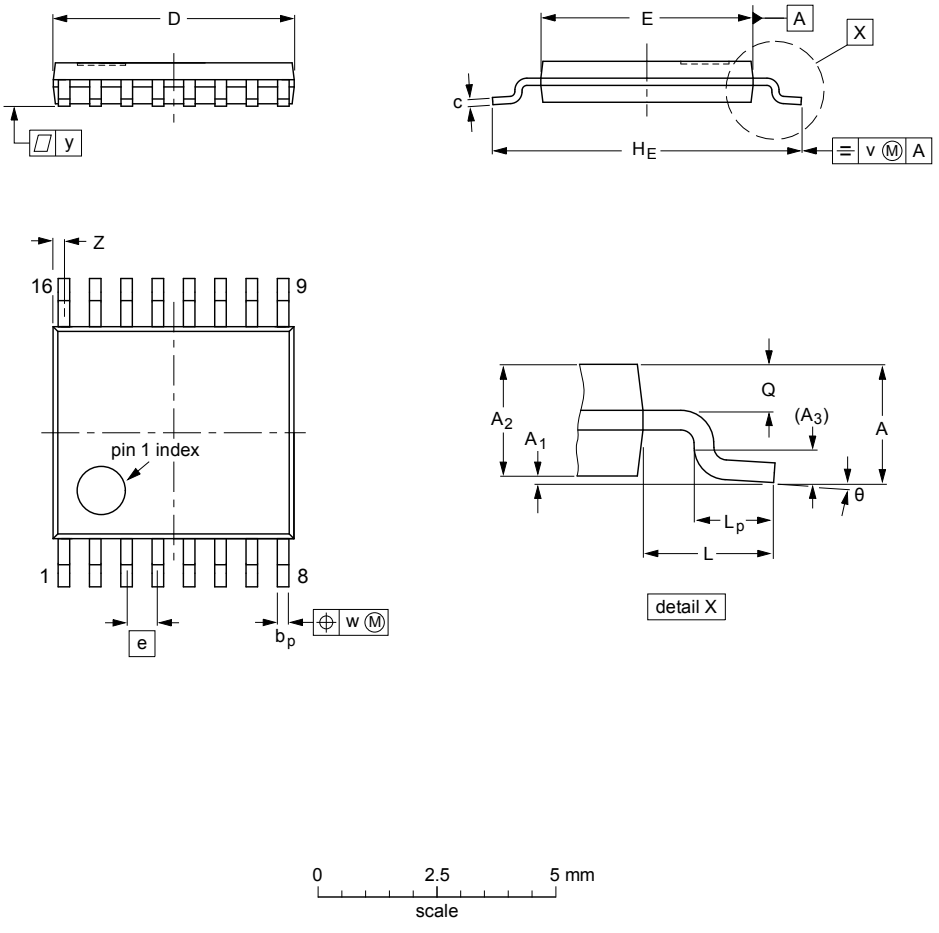
Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT338-1		MO-150				~~99-12-27~~ 03-02-19

Fig. 18. Package outline SOT338-1 (SSOP16)

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm **SOT403-1**



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A_1	A_2	A_3	b_p	c	D (1)	E (2)	e	H_E	L	L_p	Q	v	w	y	Z (1)	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.40 0.06	8° 0°

Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT403-1		MO-153				~~99-12-27~~ 03-02-18

Fig. 19. Package outline SOT403-1 (TSSOP16)

13. Abbreviations

Table 10. Abbreviations

Acronym	Description
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

14. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC_HCT163 v.5	20181012	Product data sheet	-	74HC_HCT163 v.4
Modifications:	• The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. • Legal texts have been adapted to the new company name where appropriate. • Typo corrected for pin name Q0: Fig. 5 and Fig. 6.			
74HC_HCT163 v.4	20151228	Product data sheet	-	74HC_HCT163 v.3
Modifications:	• Type numbers 74HC163N and 74HCT163N (SOT38-4) removed.			
74HC_HCT163 v.3	20140602	Product data sheet	-	74HC_HCT163_CNV v.2
Modifications:	• The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. • Legal texts have been adapted to the new company name where appropriate.			
74HC_HCT163_CNV v.2	19930927	Product specification	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.
[2] The term 'short data sheet' is explained in section "Definitions".
[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at https://www.nexperia.com.

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